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Printed: Dec 09, 2010

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PRODUCT NO.	DIM 'W'	DIM 'X'	DIM 'E'	DIM 'F'	PACKING	NOTE
10035692-001LF	2.69	13.00	1.95	2.40	TUBE	
10035692-001TLF	2.69	13.00	1.95	2.40	T&R	
10035692-011LF	2,56	12,74	0,95	3.36	TUBE	
10035692-001THLF	2.69	13.00	1.95	2.40	T&R	H FREE

1 | 2



NOTES:

1. MATERIAL

i) HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V-0, BLACK

ii) TERMINAL : COPPER ALLOY iii) HOLD DOWN: COPPER ALLOY

2. FÍNISH

i) TERMINAL: 15u" min Au PLATING AT CONTACT POINT 100u" min Sn PLATING AT SOLDER TAIL WITH

NICKEL UNDERPLATE

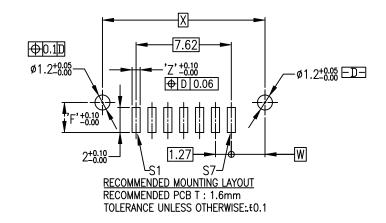
ii) HOLD DOWN: 100-200 u" Sn PLATING.

3. P/N: 10035692-XXXLF

THE HOUSING WILL WITHSTAND EXPOSURE TO 260 DEGREE C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH 1.6MM MINIMUM THICK CIRCUIT BOARD.

4. PRODUCT SPEC: GS-12-194 110-634 (10035692-001TLF ONLY)

5. PACKING SPEC: GS-14-840
PACKING TUBE&STOPPER:10020959-004&10026026-004



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PDM: Rev:D 3 STATUS: Released Printed: Dec 09, 2010